

# UNITED STATES DEPARTMENT OF COMMERCE

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FILING DATE FIRST NAMED INVENTOR ATTORNEY DOCKET NO APPLICATION NO. 7 09/018,783 02/04/98 RITZDORF 11928US01 **EXAMINER** MMC2/1004 COLLINS, D ROCKEY, MILNAMOW & KATZ TWO PRUDENTIAL PLAZA, 47TH FLOOR ART UNIT PAPER NUMBER 180 NORTH STETSON 2823 CHICAGO IL 60601 DATE MAILED:

Please find below and/or attached an Office communication concerning this application or proceeding.

**Commissioner of Patents and Trademarks** 

10/04/00

•	Office Action Summary	Application No. 09/018, 783 Examiner Deven M. Co		_	er al,
<b>X</b>	Responsive to communication(s) filed on	8-18-00			·
•	This action is FINAL.				
	Since this application is in condition for allowance ex in accordance with the practice under <i>Ex parte Quay</i>	<i>ile</i> , 1935 C.D. 11; 453	0.6. 213.		
is lo	hortened statutory period for response to this action onger, from the mailing date of this communication. lication to become abandoned. (35 U.S.C. § 133). CFR 1.136(a).	Failure to respond with	in the peno	a ioi response	Will Cause the
	position of Claims    1-3		is/are	pending in the	e application.
,	Of the above, claim(s)				n consideration.
			i	s/are allowed.	
	∑ Claim(s)		i	s/are rejected.	· •
	☐ Claim(s)				
	Claims				
	See the attached Notice of Draftsperson's Patent  The drawing(s) filed on is/ar  The proposed drawing correction, filed on  The specification is objected to by the Examiner.  The oath or declaration is objected to by the Exam	re objected to by the Ex is □ap	aminer.	_disapproved.	
Pri	ority under 35 U.S.C. § 119  Acknowledgement is made of a claim for foreign All Some* None of the CERTIFIED of received.  received in Application No. (Series Code/S received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received in this national stage application for the CERTIFIED of received.	copies of the priority do serial Number) from the International Bo	cuments ha	_ · _ · Rule 17.2(a)).	·
At	Notice of References Cited, PTO-892 Information Disclosure Statement(s), PTO-1449, Interview Summary, PTO-413 Notice of Draftsperson's Patent Drawing Review Notice of Informal Patent Application, PTO-152	Paper No(s).			

--- SEE OFFICE ACTION ON THE FOLLOWING PAGES ---

Serial Number: 09/018783 Page 2

Art Unit: 2823

#### **DETAILED ACTION**

### Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.
- 2. Claims 1, 6, 11, 18, 24 and 30 are rejected under 35 U.S.C. 102(e) as being anticipated by Teong (5,693,563 dated 12/2/97).

Teong shows the method as claimed in Figures 1-7 with corresponding text. Teong discloses the application of copper damascene connectors to a double level metal process. A dual damascene copper connector 18 whose upper surface is coplanar with the upper surface of the insulating layer 25 in which it is embedded is described. Out-diffusion of copper 8 from the connector is prevented by at least two barrier layers. One or two barrier layers (4,11) are located at the interface between the connector and the insulating layer 15 while another barrier layer comprises conductive material and covers the upper surface of the connector. When a second damascene connector 28 is formed above the first connector the conductive barrier layer

Serial Number: 09/018783 Page 3

Art Unit: 2823

facilitates good contact between the two connectors. It also acts as an etch stop layer (11,14) during the formation of the second connector with cavity (2,22), polysilicon area 3, and trench 6.

## Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 2-5, 7-10, 12-17, 19-23, 25-29, and 31 are rejected under 35 U.S.C. 103(a) as being unpatentable over Teong (5,693,563 dated 12/2/97) in view of Chan et al. (6,100,195, dated 8/8/00).

Teong shows as stated above in 35 U.S.C. 102.

However, Teong does not show CMP and electroplating.

Chan et al. disclose a method of forming a copper interconnect line (16,24) on a dielectric layer 18 by depositing a passivating metal layer with device 10, IMD layer 12, trench hole 13, diffusion barrier layer 14 and silicon oxide layer 20.

Thus it would have been obvious to one of ordinary skill in the art at the time the invention was made to have modified Teong to include CMP and electroplating because of

Serial Number: 09/018783 Page 4

Art Unit: 2823

reasonable expectation of achieving the specific result of improving the electrical connections from the problems associated with aluminum interconnect technology.

#### Conclusion

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Examiner Deven M. Collins whose telephone number is (703) 305-7840.

The examiner can normally be reached on Monday-Friday from 6:30 AM to 3:00 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael M. Fahmy, can be reached on (703) 308-4918. The fax phone number for this Group is (703) 305-3432.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956.

**DMC** 

October 2, 2000